

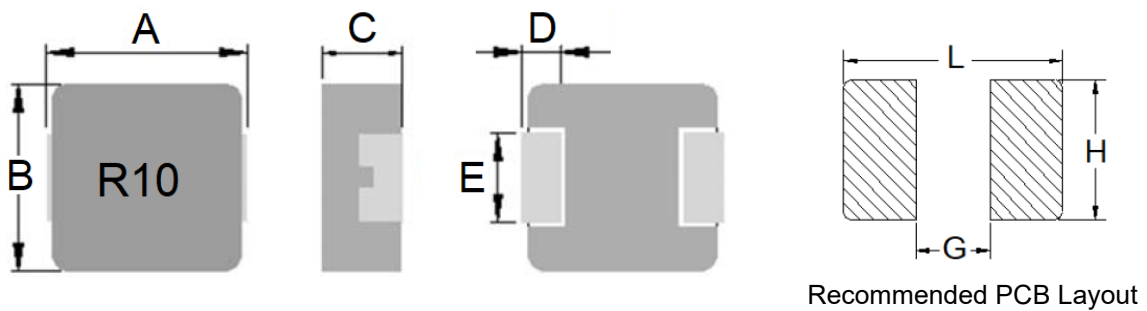
1. Part No. Expression

P I C Q 0 4 0 2 H P R 1 0 Y F

(a) (b) (c) (d) (e) (f)

- | | |
|--------------------|---------------------|
| (a) Series Code | (d) Inductance Code |
| (b) Dimension Code | (e) Tolerance Code |
| (c) Material Code | (f) Packaging Code |

2. Configuration & Dimensions (Unit: mm)

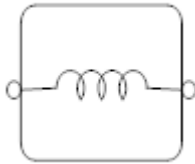


- Note:
1. The above PCB layout reference only.
 2. Recommend solder paste thickness at 0.12 mm and above.
 3. Marking: Inductance Code, Black

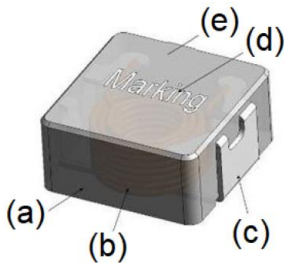
A	B	C	D	E	L	G	H
4.45±0.25	4.06±0.25	1.80±0.20	0.76±0.30	2.00±0.20	5.20 Ref	2.20 Ref	2.40 Ref

NOTE: Specifications subject to change without notice. Please check our website for latest information.

3. Schematic



4. Material List



NO	Items
(a)	Core
(b)	Wire
(c)	Clip
(d)	Ink
(e)	Paint

5. General Specifications

- (a) Reliability test for this part meets AEC-Q200 standard.
- (b) Operating Temp.: - 55°C to + 125°C (including self-temperature rise)
- (c) Storage Temp.: - 55°C to + 125°C (on board)
- (d) All test data referenced to 25°C ambient.
- (e) Heat Rated Current (Irms) will cause the coil temperature rise approximately ΔT of 40°C.
- (f) Saturation Current (Isat) will cause inductance L0 to drop approximately 30%.
- (g) Rated DC Current: The lower value of Irms and Isat.
- (h) Part Temperature (Ambient + Temp. Rise): Should not exceed 125°C under worst case operating conditions.
- (i) Maximum Operating Voltage: 40V
- (j) Storage Condition (Component in its packaging)
 - i) Temperature: Less than 40°C
 - ii) Humidity: Less than 60% RH

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6. Electrical Characteristics

Part Number	Inductance (μ H) @0A	Test Frequency	I _{rms} (A) Typ	I _{sat} (A) Typ	DCR (m Ω)	
					Typ	Max
PICQ0402HPR10YF	0.10	1.0V/100KHz	12.0	35.0	3.2	4.0
PICQ0402HPR18YF	0.18	1.0V/100KHz	13.5	28.0	4.6	5.4
PICQ0402HPR22YF	0.22	1.0V/100KHz	13.0	24.0	6.6	7.3
PICQ0402HPR33MF	0.33	1.0V/100KHz	10.0	18.0	7.8	8.6
PICQ0402HPR36MF	0.36	1.0V/100KHz	9.0	15.0	8.7	12.0
PICQ0402HPR47MF	0.47	1.0V/100KHz	8.0	12.0	11.2	14.0
PICQ0402HPR56MF	0.56	1.0V/100KHz	7.3	10.0	13.5	16.0
PICQ0402HPR68MF	0.68	1.0V/100KHz	7.0	10.0	16.0	19.0
PICQ0402HP1R0MF	1.00	1.0V/100KHz	5.0	8.5	22.0	27.0
PICQ0402HP1R2MF	1.20	1.0V/100KHz	4.8	7.8	25.0	30.0
PICQ0402HP1R5MF	1.50	1.0V/100KHz	4.5	7.0	34.8	42.0
PICQ0402HP2R2MF	2.20	1.0V/100KHz	4.0	6.0	51.0	61.0
PICQ0402HP3R3MF	3.30	1.0V/100KHz	3.5	4.0	69.0	76.0
PICQ0402HP3R6MF	3.60	1.0V/100KHz	3.1	3.8	75.0	90.0
PICQ0402HP4R7MF	4.70	1.0V/100KHz	2.6	3.5	95.0	105
PICQ0402HP5R6MF	5.60	1.0V/100KHz	2.2	3.0	112	125
PICQ0402HP6R8MF	6.80	1.0V/100KHz	2.1	2.8	150	172
PICQ0402HP8R2MF	8.20	1.0V/100KHz	2.0	2.5	158	180
PICQ0402HP100MF	10.0	1.0V/100KHz	1.8	2.3	215	243
PICQ0402HP150MF	15.0	1.0V/100KHz	1.5	1.9	325	374
PICQ0402HP200MF	20.0	1.0V/100KHz	1.3	1.7	435	480
PICQ0402HP220MF	22.0	1.0V/100KHz	1.2	1.4	470	500

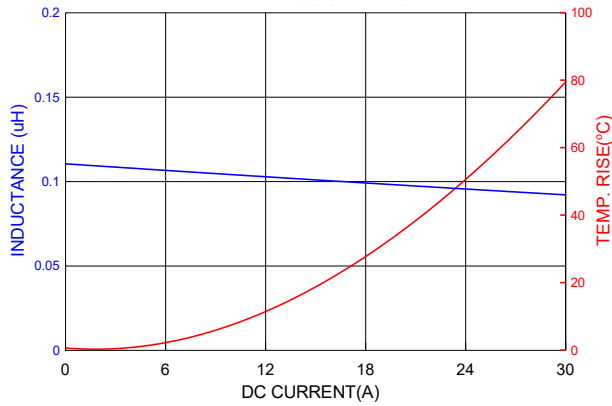
Tolerance Code: M = $\pm$ 20%, Y = $\pm$ 30%

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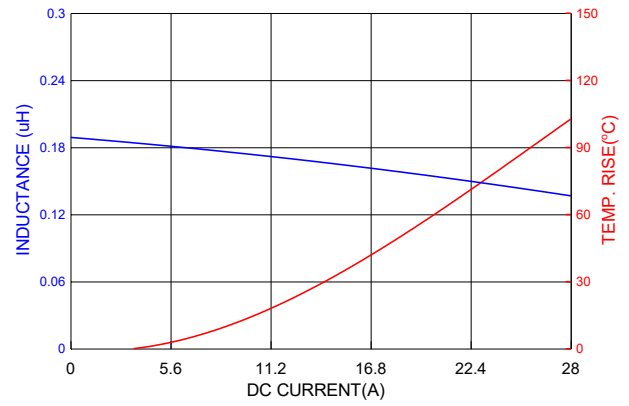


7. Characteristics Curve

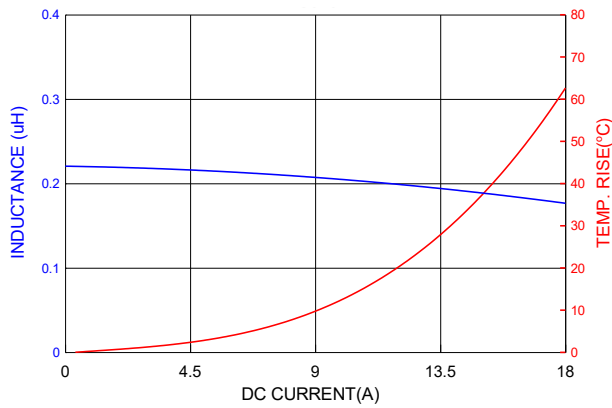
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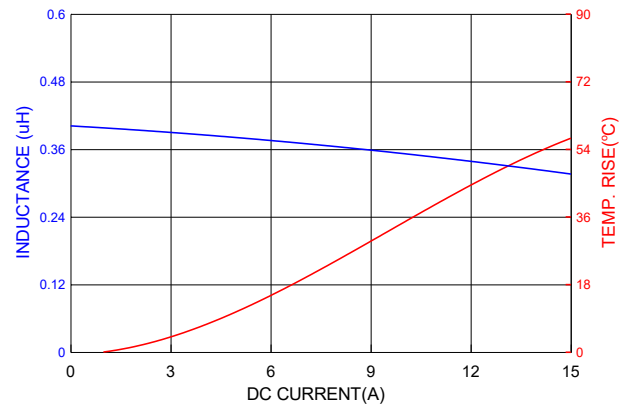
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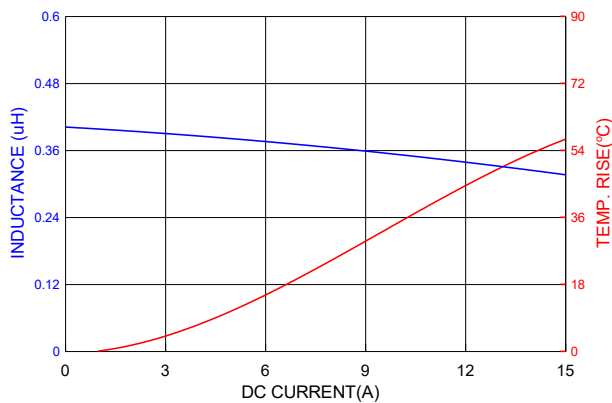
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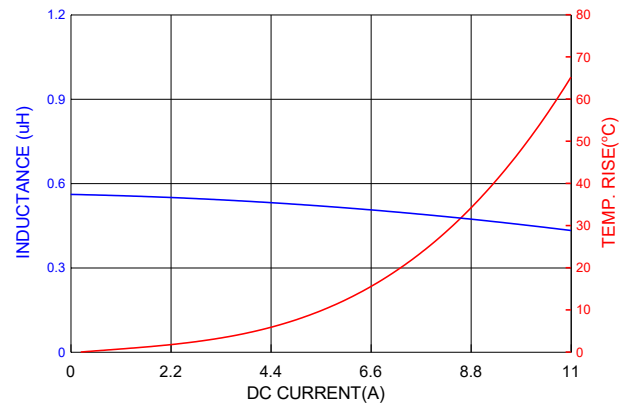
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PICQ0402HPR36MF

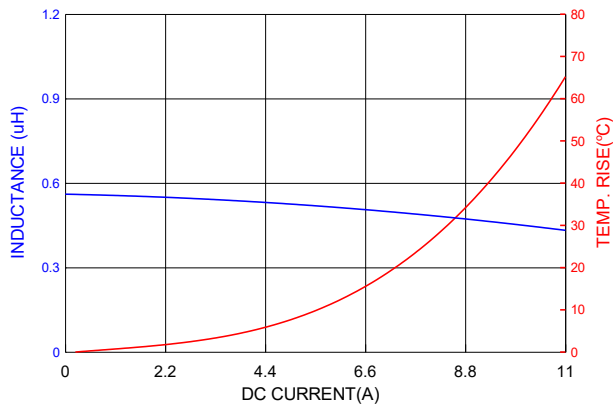


PICQ0402HPR47MF

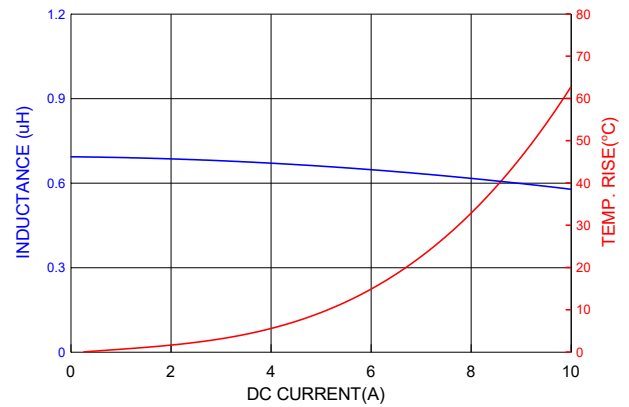


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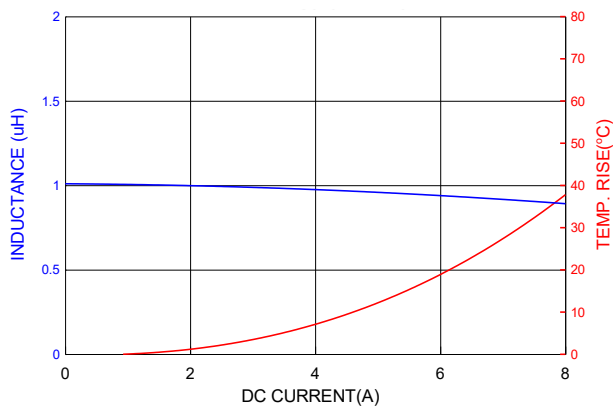
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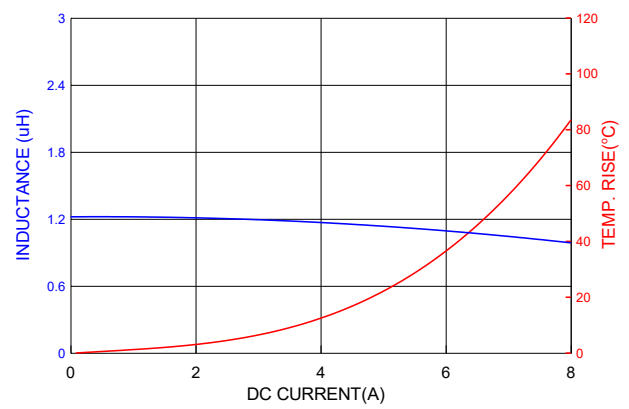
PICQ0402HPR68MF



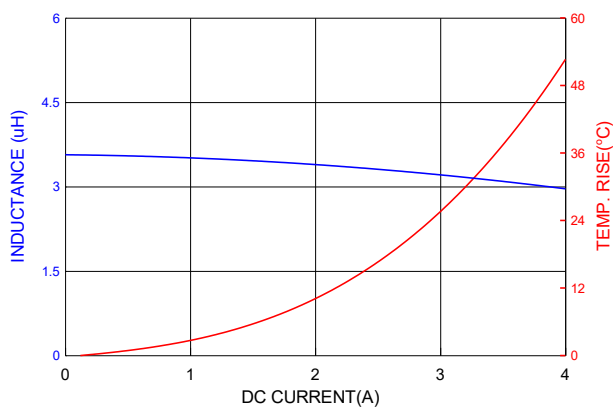
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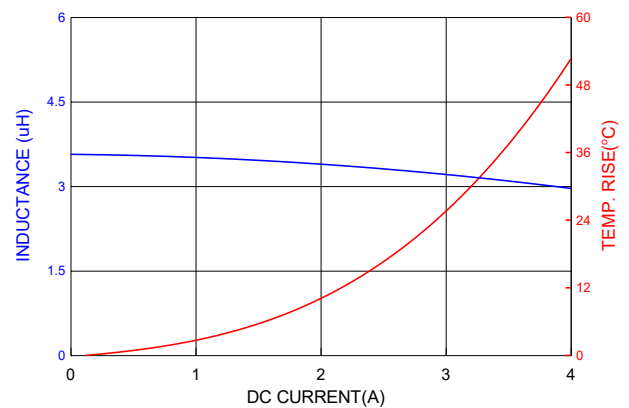
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PICQ0402HP1R5MF

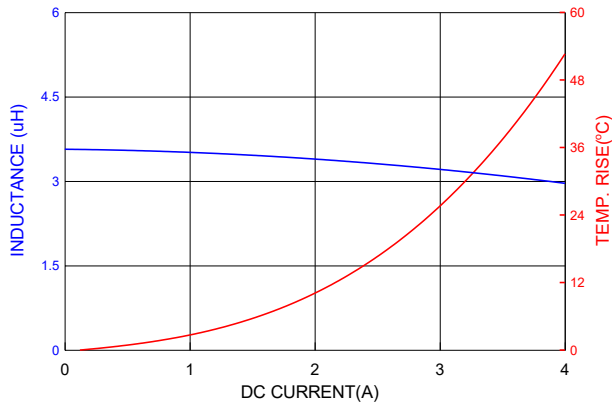


PICQ0402HP2R2MF

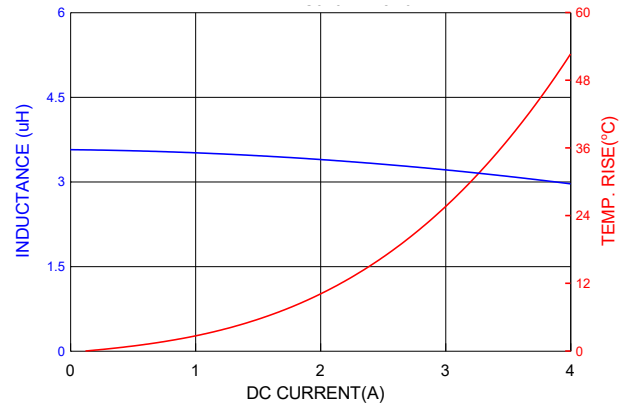


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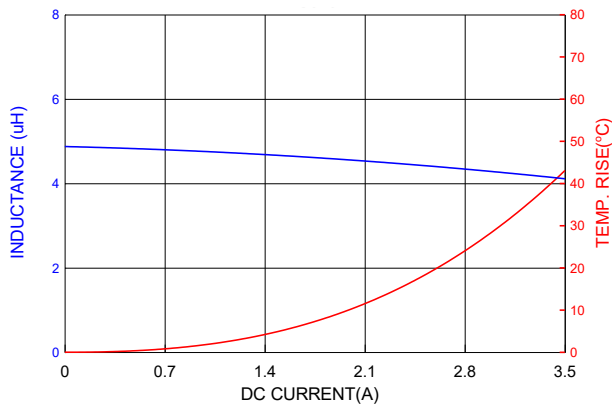
PICQ0402HP3R3MF



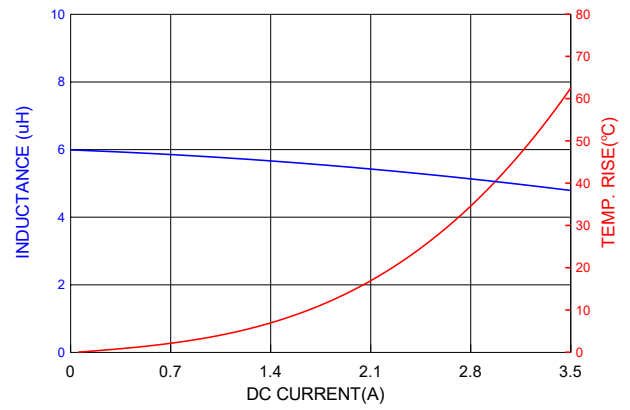
PICQ0402HP3R6MF



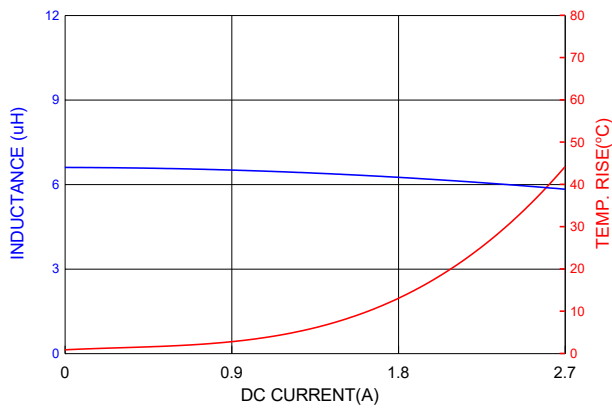
PICQ0402HP4R7MF



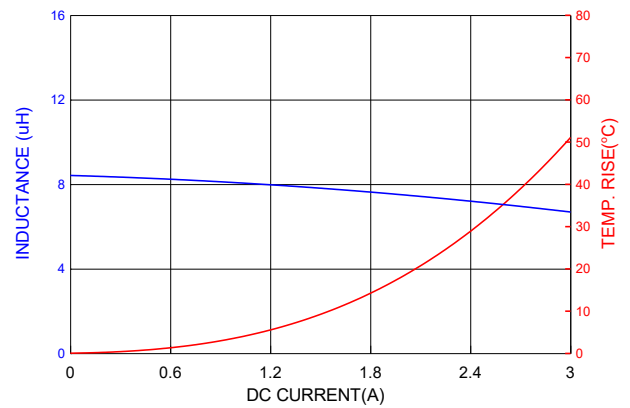
PICQ0402HP5R6MF



PICQ0402HP6R8MF

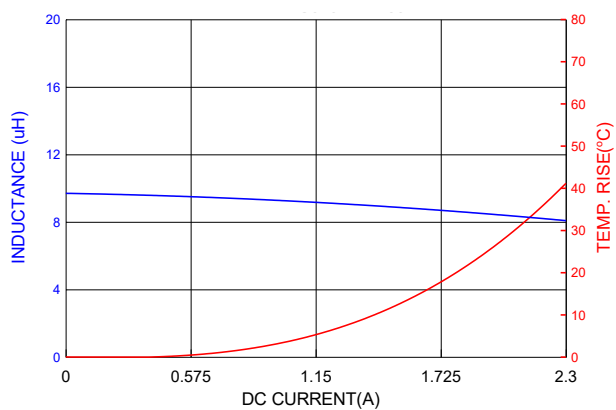


PICQ0402HP8R2MF

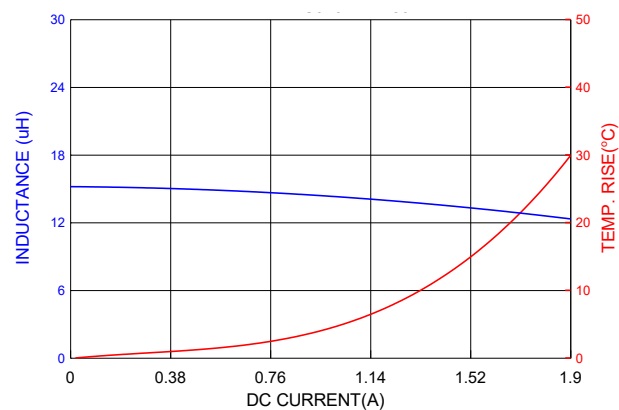


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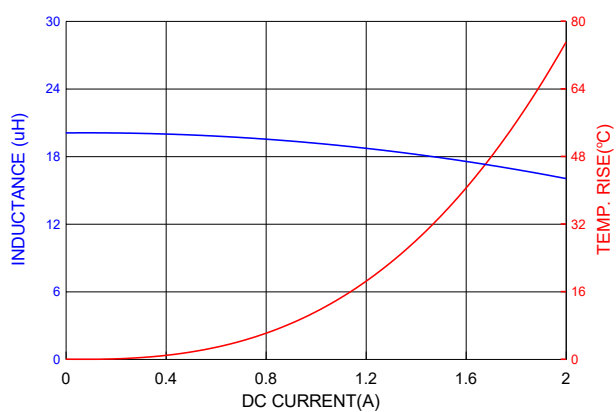
PICQ0402HP100MF



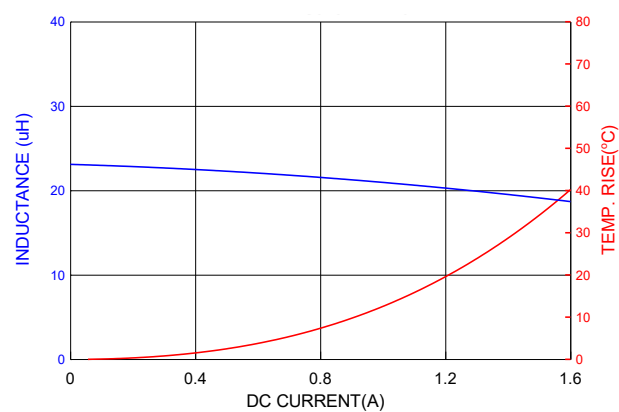
PICQ0402HP150MF



PICQ0402HP200MF



PICQ0402HP220MF



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8. Soldering Specification

Mildly activated rosin fluxes are preferred. Our terminations are suitable for re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

8-1. IR Soldering Reflow

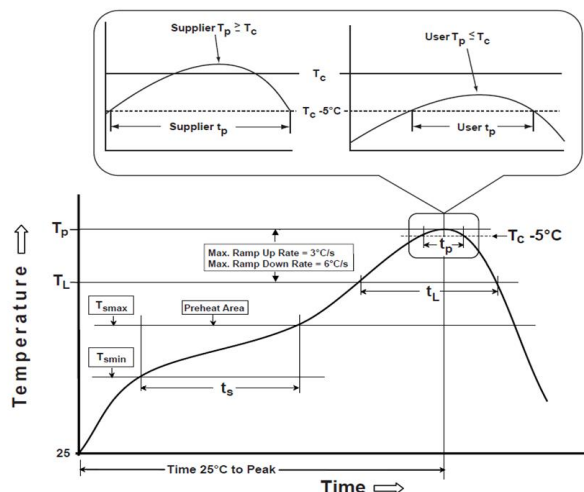
Recommended temperature profiles for lead free re-flow soldering in Figure 1, Table 1.1 & 1.2 (J-STD-020E).

8-2. Iron Reflow

Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended (Figure 2).

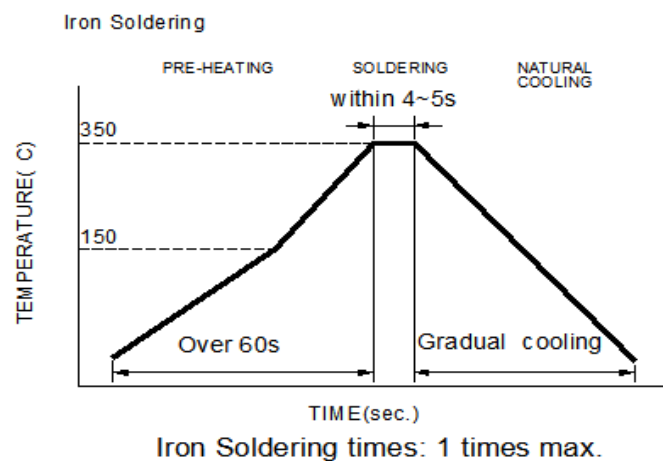
Note:

- Preheat circuit and products to 150°C.
- 355°C tip temperature (Max.)
- Never contact the ceramic with the iron tip
- 1.0mm tip diameter (Max.)
- Use a 20 watt soldering iron with tip diameter of 1.0mm
- Limit soldering time to 4~5 sec.



Reflow times: 3 times Max

Figure 1: IR Soldering Reflow



Soldering iron method: 350±5°C Max

Figure 2: Iron soldering temperature profiles

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Table (1.1) Reflow Profiles

Profile Type:	Pb-Free Assembly
Preheat	
-Temperature Min (T_{smin})	150°C
-Temperature Max (T_{smax})	200°C
-Time (t_s) from (T_{smin} to T_{smax})	60-120seconds
Ramp-up rate (T_L to T_p)	3°C /second max.
Liquids temperature (T_L)	217°C
Time (t_L) maintained above T_L	60-150 seconds
Classification temperature (T_c)	See Table (1.2)
Time (t_p) at $T_c - 5^\circ\text{C}$ (T_p should be equal to or less than T_c .)	* < 30 seconds
Ramp-down rate (T_p to T_L)	6°C /second max.
Time 25°C to peak temperature	8 minutes max.

T_p: maximum peak package body temperature, **T_c**: the classification temperature.

For user (customer) **T_p** should be equal to or less than **T_c**.

*Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum.

Table (1.2) Package Thickness/Volume and Classification Temperature (T_c)

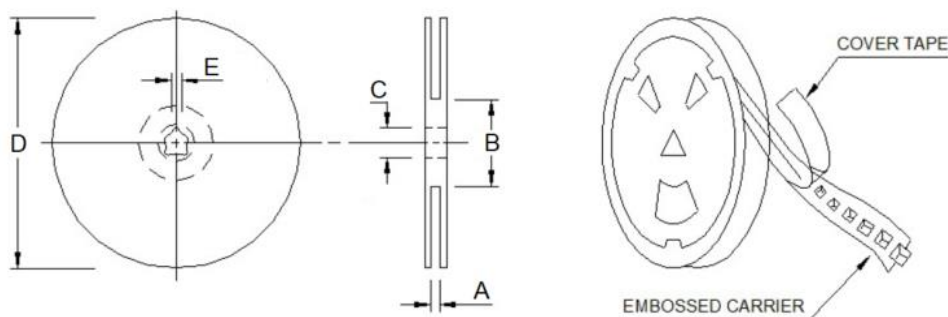
	Package Thickness	Volume mm ³ <350	Volume mm ³ 350-2000	Volume mm ³ >2000
PB-Free Assembly	<1.6mm	260°C	260°C	260°C
	1.6-2.5mm	260°C	250°C	245°C
	≥2.5mm	250°C	245°C	245°C

Reflow is referred to standard IPC/JEDEC J-STD-020E.

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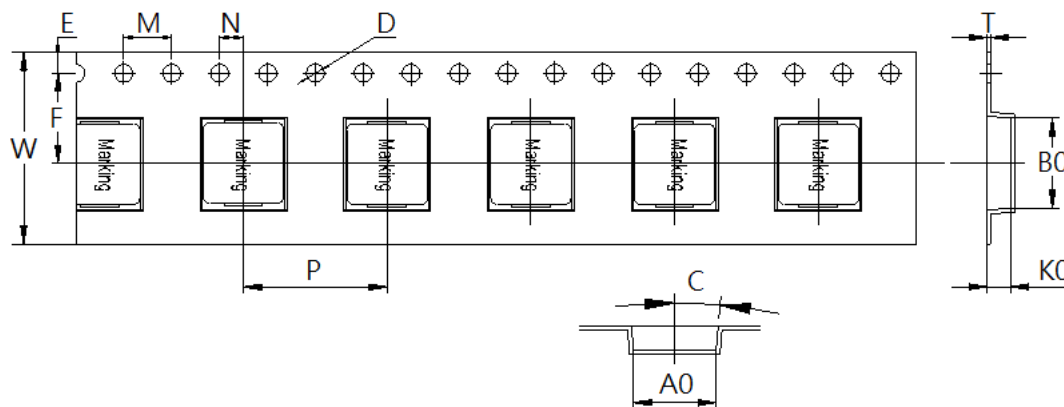
9. Packaging Information

9-1. Reel Dimension (Unit: mm)



Type	A	B	C	D	E
13"x12mm	12.4+2.0/-0.0	100.0±2.0	13.0+0.5/-0.2	330.0	2.0±0.5

9-2. Tape Dimension (Unit: mm)



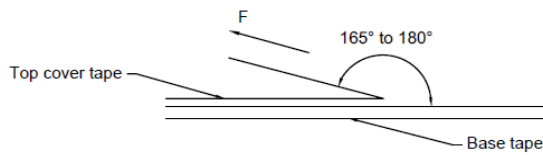
B0	A0	K0	P	W	F
5.00±0.10	4.40±0.10	2.30±0.10	8.00±0.10	12.00±0.30	5.50±0.10
T	E	M	N	D	C
0.35±0.05	1.75	4.00	2.00	1.50	3°

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9-3. Packaging Quantity (Unit: Pcs)

Chip/ Reel	3,000
Inner box	6,000
Carton	24,000

9-4. Tearing Off Force



The force for tearing off cover tape is according to the follow table, in the arrow direction under the following conditions.

(Referenced ANSI/EIA-481-D-2008 of 4.11 standard)

Room Temp. (°C)	Room Humidity (%)	Room atm (hPa)	Tearing Speed (mm/min)
5~35	45~85	860~1060	300±10

Tape Size	8 mm	12 to 56 mm	72 mm or Wider
Tearing Off Force (grams)	10~100	10~130	10~150

Application Notice

1. Storage Conditions

To maintain the solderability of terminal electrodes:

- (a) Recommended products should be used within 12 months from the time of delivery.
- (b) The packaging material should be kept where no chlorine or sulfur exists in the air.

2. Transportation

- (a) Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- (b) Vacuum pick up is strongly recommended for individual components.
- (c) Bulk handling should ensure that abrasion and mechanical shock are minimized.

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